





#### 100V PNP MEDIUM POWER TRANSISTOR IN SOT89

#### **Features**

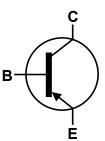
- BV<sub>CEO</sub> > -100V
- I<sub>C</sub> = -1A high Continuous Collector Current
- I<sub>CM</sub> = -2A Peak Collector Current
- Low saturation voltage V<sub>CE(sat)</sub> < -200mV @ -250mA</li>
- Complementary NPN type: FCX493
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

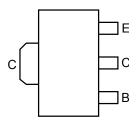
- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208@3
- Weight: 0.05 grams (Approximate)







Device Symbol



Top View Pin Out

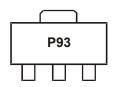
#### Ordering Information (Note 4)

| Product  | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|----------|---------|--------------------|-----------------|-------------------|
| FCX593TA | P93     | 7                  | 12              | 1,000             |

Notes:

- $1.\ No\ purposely\ added\ lead.\ Fully\ EU\ Directive\ 2002/95/EC\ (RoHS)\ \&\ 2011/65/EU\ (RoHS\ 2)\ compliant.$
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



P93 = Product Type Marking Code



#### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic               | Symbol           | Limit | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage       | $V_{CBO}$        | -120  | V    |
| Collector-Emitter Voltage    | V <sub>CEO</sub> | -100  | V    |
| Emitter-Base Voltage         | $V_{EBO}$        | -7    | V    |
| Continuous Collector Current | Ic               | -1    | Α    |
| Peak Pulse Current           | I <sub>CM</sub>  | -2    | Α    |

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                | Symbol          | Value             | Unit |      |  |
|---|-----------------|-------------------|------|------|--|
|   | (Note 5)        |                   | 1    |      |  |
| Power Dissipation                             | (Note 6)        | $P_{D}$           | 1.5  | W    |  |
|   | (Note 7)        |                   | 2.0  | ]    |  |
|   | (Note 5)        |                   | 125  | °C/W |  |
| Thermal Resistance, Junction to Ambient Air   | (Note 6)        | $R_{\theta JA}$   | 83   |      |  |
|   | (Note 7)        |                   | 60   |      |  |
| Thermal Resistance, Junction to Lead (Note 8) |                 | R <sub>0JL</sub>  | 22   |      |  |
| Thermal Resistance, Junction to Case          | (Note 9)        | R <sub>θ</sub> JC | 16   |      |  |
| Operating and Storage Temperature Range       | $T_{J,}T_{STG}$ | -55 to +150       | °C   |      |  |

### ESD Ratings (Note 10)

| Characteristic                             | Symbol  | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V    | 3A          |
| Electrostatic Discharge - Machine Model    | ESD MM  | 400   | V    | С           |

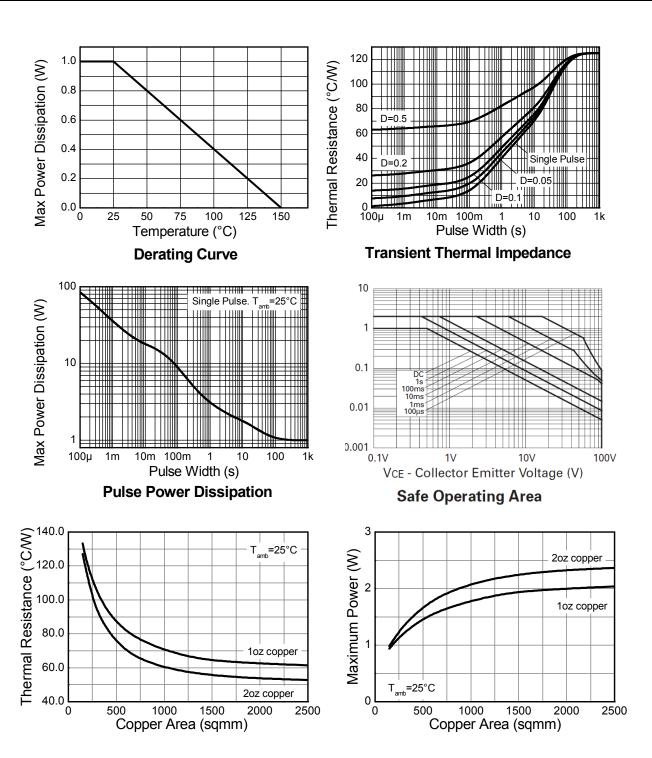
Notes:

- 5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as note (5), except the device is mounted on 25mm x 25mm 1oz copper.
- 7. Same as note (5), except the device is mounted on 50mm x 50mm 1oz copper. 8. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 9. Thermal resistance from junction to the top of the case.
- 10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.





## **Thermal Characteristics and Derating Information**







# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

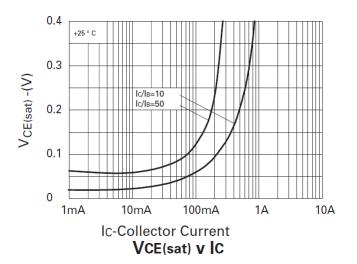
| Characteristic                                 | Symbol               | Min                     | Тур | Max           | Unit | Test Condition  |
|--|----------------------|-------------------------|-----|---------------|------|---|
| Collector-Base Breakdown Voltage               | BV <sub>CBO</sub>    | -120                    | _   | _             | V    | I <sub>C</sub> = -100μA   |
| Collector-Emitter Breakdown Voltage (Note 11)  | BV <sub>CEO</sub>    | -100                    | _   | _             | V    | I <sub>C</sub> = -10mA  |
| Emitter-Base Breakdown Voltage                 | BV <sub>EBO</sub>    | -7                      | _   | _             | V    | I <sub>E</sub> = -100μA   |
| Collector Cutoff Current                       | I <sub>CBO</sub>     | _                       | _   | -100          | nA   | V <sub>CB</sub> = -100V   |
| Emitter Cutoff Current                         | I <sub>EBO</sub>     | _                       | _   | -100          | nA   | V <sub>EB</sub> = -5V   |
| Emitter Cutoff Current                         | I <sub>CES</sub>     | _                       | _   | -100          | nA   | V <sub>CES</sub> = -100V  |
| DC current transfer Static ratio (Note 11)     | h <sub>FE</sub>      | 100<br>100<br>100<br>50 | _   | —<br>300<br>— | _    | $\begin{split} & I_{C} = -1 \text{mA}, \ V_{CE} = -5 \text{V} \\ & I_{C} = -250 \text{mA}, \ V_{CE} = -5 \text{V} \\ & I_{C} = -500 \text{mA}, \ V_{CE} = -5 \text{V} \\ & I_{C} = -1 \text{A}, \ V_{CE} = -5 \text{V} \end{split}$ |
| Collector-Emitter Saturation Voltage (Note 11) | V <sub>CE(sat)</sub> |                         | _   | -0.2<br>-0.3  | V    | $I_C$ = -250mA, $I_B$ = -25mA<br>$I_C$ = -500mA, $I_B$ = -50mA  |
| Base-Emitter Saturation Voltage (Note 11)      | V <sub>BE(sat)</sub> | _                       | _   | -1.1          | V    | $I_C = -500 \text{mA}, I_B = -50 \text{mA}$   |
| Base-Emitter Turn-on Voltage (Note 11)         | V <sub>BE(on)</sub>  | _                       | _   | -1.0          | V    | $I_C = -1 \text{mA}, V_{CE} = -5 \text{V}$  |
| Transitional Frequency                         | f <sub>T</sub>       | 50                      | _   | _             | MHz  | $I_E = -50 \text{mA}, V_{CE} = -10 \text{V}$<br>f = 100MHz  |
| Output capacitance                             | C <sub>obo</sub>     | _                       | _   | 5             | pF   | V <sub>CB</sub> = -10V, f = 1MHz,   |

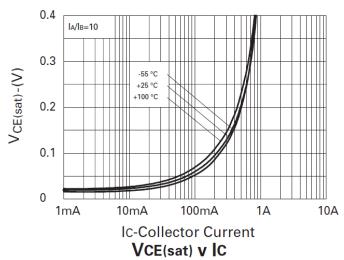
Note: 11. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

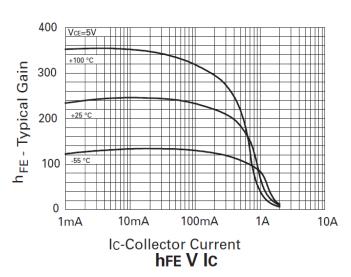


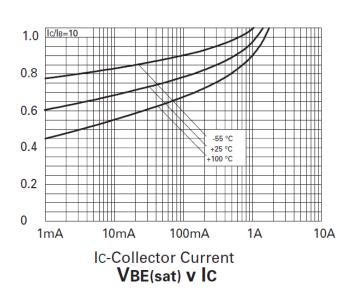


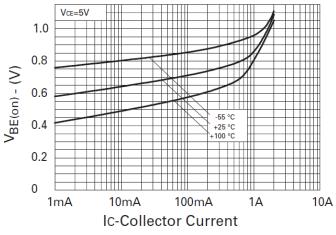
# Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)









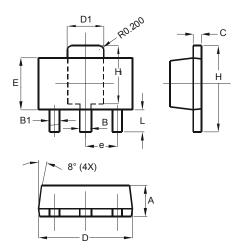






### **Package Outline Dimensions**

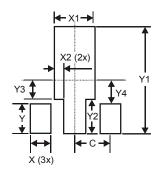
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SOT89                |          |      |  |  |
|----------------------|----------|------|--|--|
| Dim                  | Min      | Max  |  |  |
| Α                    | 1.40     | 1.60 |  |  |
| В                    | 0.44     | 0.62 |  |  |
| B1                   | 0.35     | 0.54 |  |  |
| С                    | 0.35     | 0.44 |  |  |
| D                    | 4.40     | 4.60 |  |  |
| D1                   | 1.62     | 1.83 |  |  |
| Е                    | 2.29     | 2.60 |  |  |
| е                    | 1.50 Typ |      |  |  |
| I                    | 3.94     | 4.25 |  |  |
| H1                   | 2.63     | 2.93 |  |  |
| L                    | 0.89     | 1.20 |  |  |
| All Dimensions in mm |          |      |  |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х          | 0.900         |
| X1         | 1.733         |
| X2         | 0.416         |
| Υ          | 1.300         |
| Y1         | 4.600         |
| Y2         | 1.475         |
| Y3         | 0.950         |
| Y4         | 1.125         |
| С          | 1.500         |

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.





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